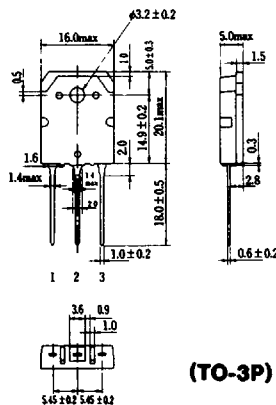
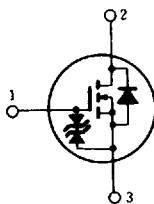


SILICON N-CHANNEL MOS FET

HIGH SPEED POWER SWITCHING

■ FEATURES

- Low On-Resistance
- High Speed Switching
- Low Drive Current
- No Secondary Breakdown
- Suitable for Switching Regulator and DC-DC Converter



1. Gate
2. Drain
(Flange)
3. Source
(Dimensions in mm)

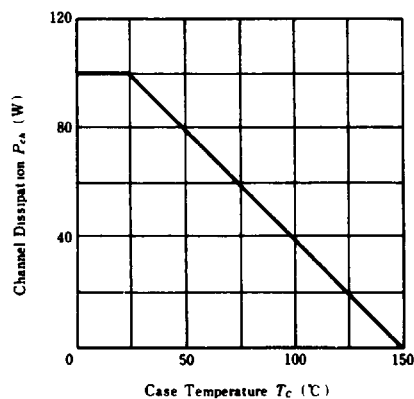
■ **ABSOLUTE MAXIMUM RATINGS** ($T_a=25^{\circ}\text{C}$)

Item	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	250	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current	I_D	15	A
Drain Peak Current	$I_{D(pulse)^{*}}$	60	A
Body-Drain Diode Reverse Drain Current	I_{DR}	15	A
Channel Dissipation	P_{CA}^{**}	100	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature	T_{stg}	-55~+150	°C

*PW $\leq 10\mu\text{s}$, duty cycle $\leq 1\%$

** Value at $T_c = 25^\circ\text{C}$

POWER VS. TEMPERATURE DERATING

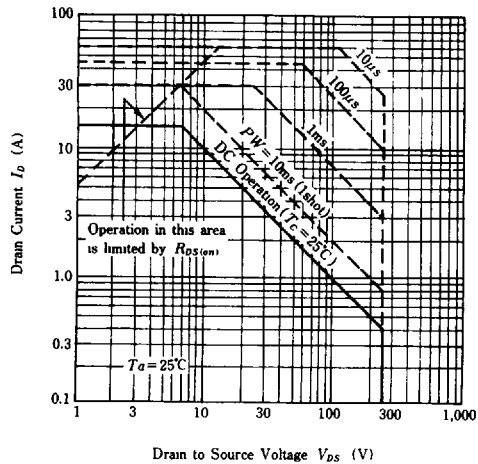


■ ELECTRICAL CHARACTERISTICS ($T_a=25^{\circ}\text{C}$)

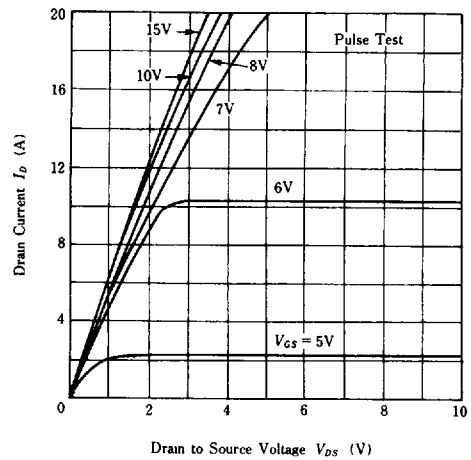
Item	Symbol	Test Condition	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=10\text{mA}, V_{GS}=0$	250	—	—	V
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G=\pm 100\mu\text{A}, V_{DS}=0$	± 20	—	—	V
Gate-Source Leak Current	I_{GSS}	$V_{GS}=\pm 16\text{V}, V_{DS}=0$	—	—	± 10	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=200\text{V}, V_{GS}=0$	—	—	250	μA
Gate-Source Cutoff Voltage	$V_{GS(off)}$	$I_D=1\text{mA}, V_{DS}=10\text{V}$	2.0	—	4.0	V
Static Drain-Source on State Resistance	$R_{DS(on)}$	$I_D=8\text{A}, V_{GS}=10\text{V}^*$	—	0.16	0.22	Ω
Forward Transfer Admittance	$ y_{fs} $	$I_D=8\text{A}, V_{DS}=10\text{V}^*$	5.0	8.5	—	S
Input Capacitance	C_{iss}	$V_{DS}=10\text{V}, V_{GS}=0, f=1\text{MHz}$	—	1600	—	pF
Output Capacitance	C_{oss}		—	770	—	pF
Reverse Transfer Capacitance	C_{rss}		—	230	—	pF
Turn-On Delay Time	$t_{d(on)}$	$I_D=8\text{A}, V_{GS}=10\text{V}, R_L=3.75\Omega$	—	25	—	ns
Rise Time	t_r		—	130	—	ns
Turn-Off Delay Time	$t_{d(off)}$		—	110	—	ns
Fall Time	t_f		—	80	—	ns
Body-Drain Diode Forward Voltage	V_{DF}	$I_F=15\text{A}, V_{GS}=0$	—	1.2	—	V
Body-Drain Diode Reverse Recovery Time	t_{rr}	$I_F=15\text{A}, V_{GS}=0, di_F/dt=50\text{A}/\mu\text{s}$	—	500	—	ns

* Pulse Test

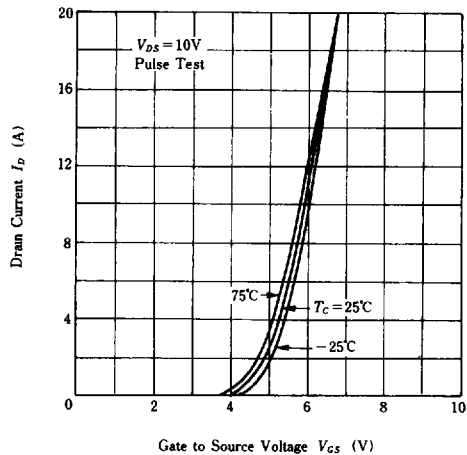
MAXIMUM SAFE OPERATION AREA



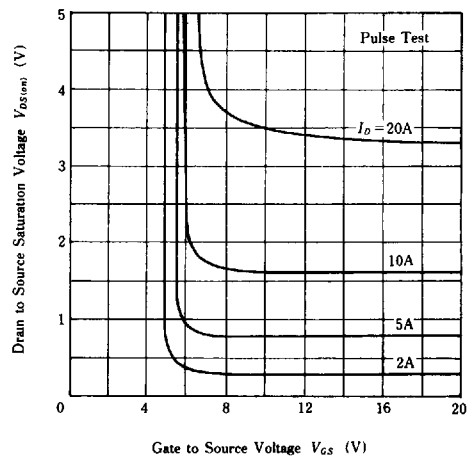
TYPICAL OUTPUT CHARACTERISTICS



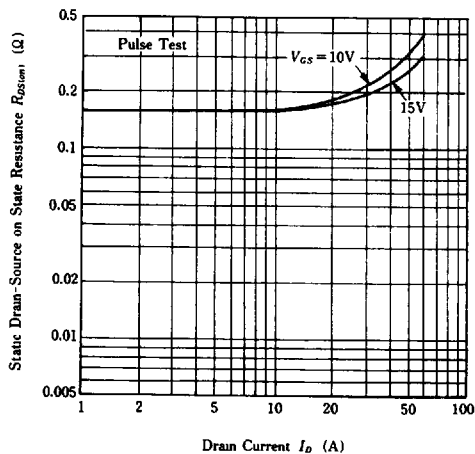
TYPICAL TRANSFER CHARACTERISTICS



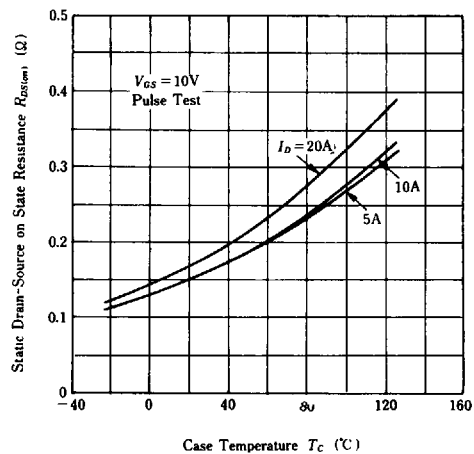
DRAIN-SOURCE SATURATION VOLTAGE VS. GATE-SOURCE VOLTAGE



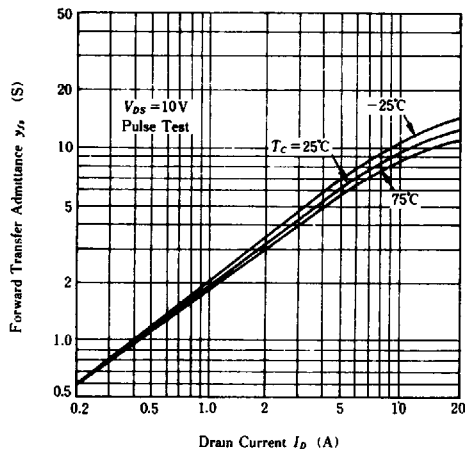
STATIC DRAIN-SOURCE ON STATE RESISTANCE VS. DRAIN CURRENT



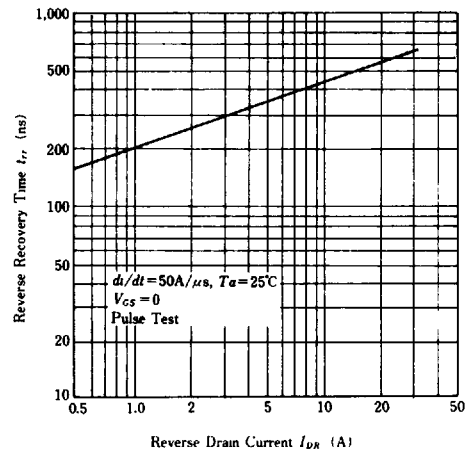
STATIC DRAIN-SOURCE ON STATE RESISTANCE VS. TEMPERATURE



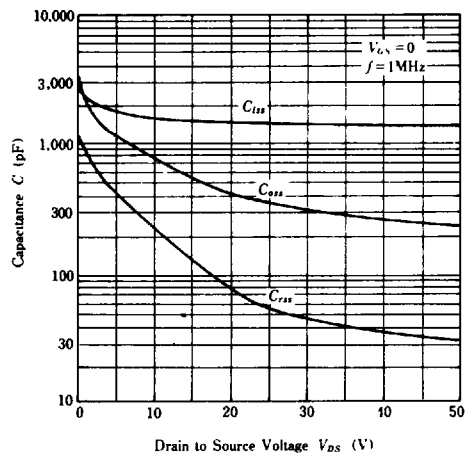
FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT



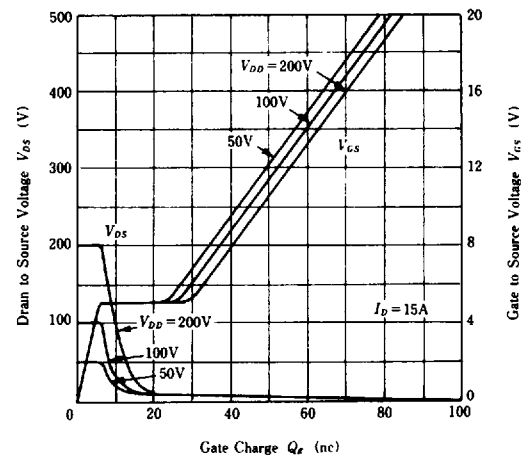
BODY-DRAIN DIODE REVERSE RECOVERY TIME



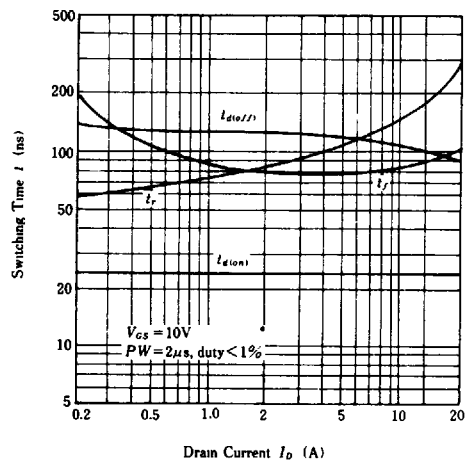
TYPICAL CAPACITANCE VS. DRAIN-SOURCE VOLTAGE



DYNAMIC INPUT CHARACTERISTICS



SWITCHING CHARACTERISTICS



REVERSE DRAIN CURRENT VS. SOURCE TO DRAIN VOLTAGE

